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COUNT	DESCRIPTION	OF REVIS	IONS	BY	CHKD	DATE		COUNT	DESCRIPTION OF RE	/ISIONS	BY	CHKD	DA	TE
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APPLICA	BLE STAND	ARD									-			
	OPERATING	DANCE	-35	°C T	· +8	5 °C(NC	TE1	STOF	RAGE TEMPERATURE	-10	°C 1		-60	۰.
RATING	VOLTAGE		-35 °C TO +85 °C(NOTE1) RAN						GE -10 °C TO + LICABLE CONNECTOR D F 2 2 * * S - 7					
	CURRENT		APE					APP	PLICABLE CABLE					
	CURREN	l I	AWG14: 18A AWG16: 15A ''					UL1015:AWG1					16	
		7				ECIFI	CAI		<u>IS</u>					
	ГЕМ	<u> </u>		TES	T ME	THOD			REQUIR	EMEN	ITS		QT	AT
	RUCTION									·				
GENERAL E	VISUALLY AND BY MEASURING INSTRUMENT.							ACCORDING TO DRAWING.					0	
MARKING		CONFIR	MED V	ISUAL	.LY.								0	0
	IC CHARAC	CTERIS	TICS	}										**********
CONTACT F	RESISTANCE	100 mA (DC OR 1000 Hz).							mΩ MAX.					
CONTACT F MILLIVOLT METHOD	20 mV MAX. 1 mA(DC OR 1000 Hz).							INITIAL RESISTANCE: 5 mΩ MAX.						
INSULATIO	1000 V DC.							1000 MΩ MIN.				0	<u> </u>	
VOLTAGE F	2500	V AC	OR 1	min.				NO FLASHOVER OR BREAKDOWN.					 _ 	
MECHAI	VICAL CHAI	RACTE	RIST	ICS					<u></u>					<u>. </u>
CONTACT I AND EXTRA FORCES	0.8 ± 0.002 × 1.6 ± 0.002 BY STEEL GAUGE.							INSERTION FORCE EXTRACTION FORCE			- (***** *********	0	_	
INSERTION WITHDRAW	MEASURED BY APPLICABLE CONNECTOR.							INSERTION FORCE		N MA		 	_	
MECHANIC	30 TIMES INSERTIONS AND EXTRACTIONS.							①CONTACT RESISTANCE: 10 mΩ MAX. ②NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					_	
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, - m/s ² AT 2h, FOR 3 DIRECTIONS.							①NO ELECTRICAL D 1 μs.	SCONTI	NUITY	OF	0	_	
SHOCK								②CONTACT RESISTA ③NO DAMAGE, CRAC OF PARTS.				0		
ENVIRO	VMENTAL (HARA	CTE	RIST	ICS				OFFARIS.				L	l
RAPID CHA						i→ 85 →	5~35°	,C	①CONTACT RESISTA	NCE: 10	mΩ M	AX.	10	Ι
TEMPERATURE		TIME 30 \rightarrow 5 \rightarrow 30 \rightarrow 5 min UNDER 5 CYCLES.							②INSULATION RESISTANCE:1000 MΩ MIN. ③NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					
DAMP HEAT (STEADY ST	EXPOSED AT 40 ± 2 °C, 90 ∼ 95 %, 96 h.							①CONTACT RESISTANCE: 10 m Ω MAX. ②INSULATION RESISTANCE: 500 M Ω MIN. ③NO DAMAGE, CRACK OR LOOSENESS OF PARTS.						
RESISTANO SOLDERING	SOLDER TEMPERATURE, °C. FOR. IMMERSION, DURATION, s.							NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.					_	
SOLDERAB	SOLDERED AT SOLDER TEMPERATURE, °C FOR IN IMMERSION, DURATION. s.							SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.						
Unless oth	LUDE THE TEM	fied, ref	er to	MIL-S	STD-1	344.	J.M.	RAWN Yayah	DESIGNED CHE 1 of Mysophil X. A 9 oc. 2 4 'co	ECKED		OVED tayou	RELE	ASEC
LP C	ualification Test	MT. ASSU	ance I	est (PART NO.					
On	HIROSE ELE				SPI	ECIFIC	ATIC		HEET DF 2	2 A -	- 1 4	1 6	S C	
CODE NO.(OL	(ט.	D	RAWIN		C4-16	33018		PA	RT NO	100	J 5	_ 1		1/

